

RoHS Compliant

REV	DATE	DESCRIPTION	ECN NO.	NAME
A	17.05.25	PROPOSAL		JIN
A1	17.06.09	Δ MODIFY		JIN

1213-SERIES SFF-8639 RECEPTACLE CONNECTOR

NOTE

1.MATERIAL

HOUSING : HIGE THERMOPLASTIC, UL94V-0,BLACK.

CAP : HIGE THERMOPLASTIC, UL94V-0,BLACK.

TERMINAL : COPPER ALLOY,

BOARD LOCK : COPPER ALLOY,

2.PLATING

TERMINAL : SELECTIVE Au ON CONTACT AREA,(SEE ORDER INFORMATION)

100u" MIN. Sn PLATED ON SOLDER TAIL AREA,

BOTH OVER 50u" MIN. Ni UNDERPLATED OVERALL.

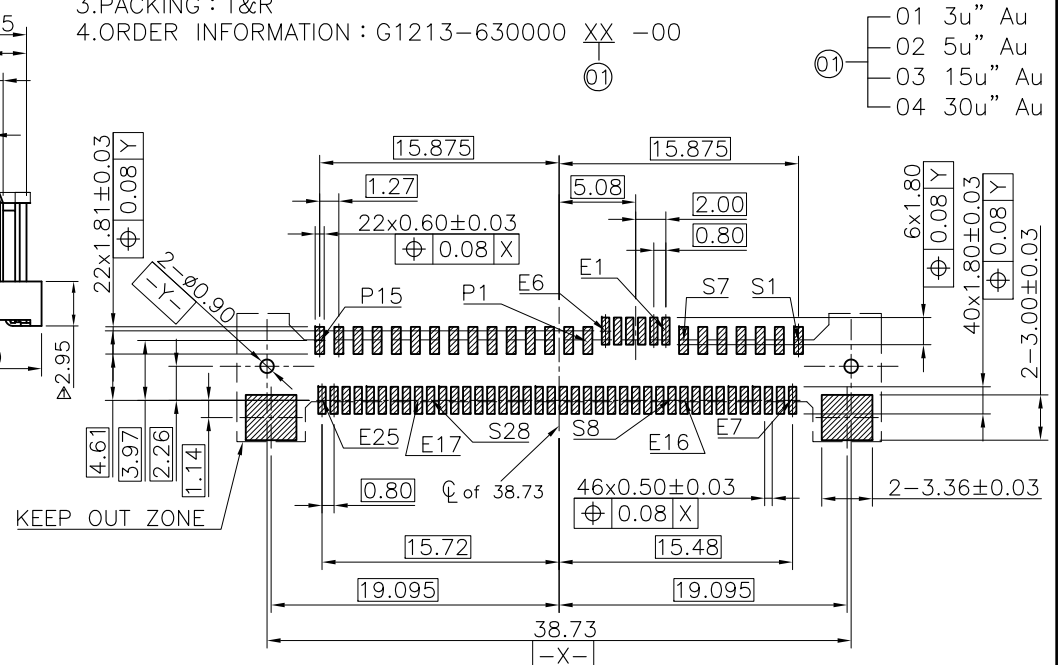
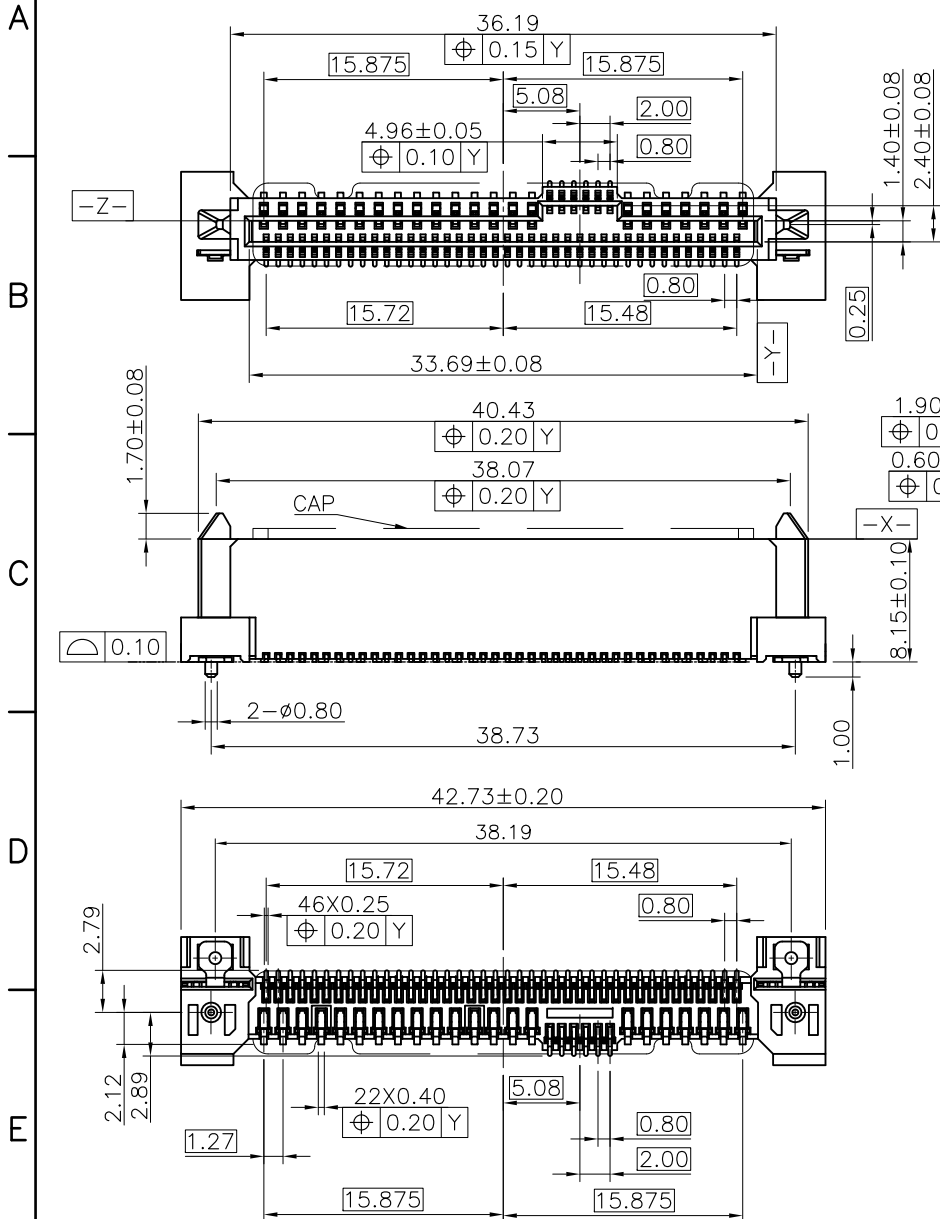
BOARD LOCK : 100u" MIN.Sn PLATED ON SOLDER TAIL AREA,

BOTH OVER 50u" MIN. Ni UNDERPLATED OVERALL.

3.PACKING : T&R

4.ORDER INFORMATION : G1213-630000 XX -00

- ① 01 3u" Au
- ① 02 5u" Au
- ① 03 15u" Au
- ① 04 30u" Au



GENERAL TOLERANCE		WIESON TECHNOLOGIES CO., LTD		PART NO.:	
X.X	=±0.20	DRAWN BY		JIN	DRAWING NO.
X.XX	=±0.15	CHECKED BY		HSIEN	G1213-630000XX-00
X.X*	=±3°	APPROVED BY		HSIEN	DRAWING SIZE
①		SORTING NO.		WST	2 : 1 A4
					UNIT
					mm
					PAGE
					1 OF 1